Surface Mount PIN Diode Limiter LM102202-H-C-301 Series Datasheet



Features

- Surface Mount Limiter in Compact Outline: 8mm L x 5mm W x 2.5 mm H
- Incorporates PIN Limiter & Schottky Diodes, D.C. Blocks & D.C. Return
- Higher Average Power Handling than Plastic (50 W C.W. Power)
- Lower Insertion Loss (0.8 dB) & Lower Flat Leakage Power (17 dBm)
- · RoHS Compliant



Description

The LM102202-H-C-301 Surface Mount Silicon PIN Diode Limiters is manufactured using Aeroflex-Metelics proven hybrid manufacturing process incorporating PIN Diodes and passive devices integrated within a ceramic substrate. This low profile, compact, surface mount component, (8mm L x 5mm W x 2.5 mm H) offers superior low and high signal performance to comparable MMIC devices in QFN packages. The Limiter Modules are designed to optimize small signal insertion loss, (N.F.) and high signal flat leakage performance in a compact, surface mount package.

Using PIN Diodes with lower thermal resistance (< 10 $^{\circ}$ C/W), and a De-coupled Schottky detector network as a current source, RF C.W. incident power levels of +47 dBm and RF peak incident power levels of +53 dBm @ 20 μ S RF pulse width, 1% duty cycle are very achievable. In addition, this design concept provides lower flat leakage power (< + 17 dBm) and lower spike leakage energy (< 0.5 Ergs) for superior LNA protection

Applications

This LM102202-H-C-301 Limiter is ideal for octave band Radar applications, requiring high volume, surface mount, solder re-flow manufacturing. These products are durable, reliable, and capable of meeting all military, commercial, and industrial environments. These devices are RoHS compliant and are available in tube or tape-reel.

Environmental Capabilities

The LM102202-H-C-301 Limiter is capable of meeting the environmental requirements of MIL-STD-750 and MIL-STD-202.

ESD and Moisture Sensitivity Level Rating

PIN Diode Limiters are susceptible to ESD conditions as with all semiconductors. The ESD rating for this device is Class 0, HBM. The moisture sensitivity level rating for this device is MSL 1.

Thermal Grounding Caution

Product engineering dictates that the LM Family of high power limiters require proper heat sinking for high power applications > 40 dBm (10W). Aeroflex /Metelics recommends using the Aeroflex / Metelics Part Number PNMN13881 heat sink block which was developed for LM family.



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LM102202-H-C-301 Electrical Specifications @ Zo = 50 Ω , TA=+ 25 °C (Unless Otherwise Defined)

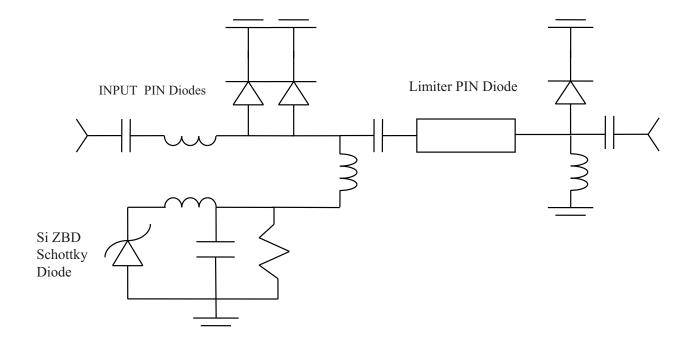
Parameter	Symbol	Units	Test Conditions	Minimum Value	Typical Value	Maximum Value
Frequency	F	GHz	Swept Frequency	0.8	1.0 - 2.0	2.5
Insertion Loss	ΙL	dB	Swept Frequency Po = 0 dBm		-0.7	-0.9
Return Loss	RL	dB	Swept Frequency Po = 0 dBm	-15	-16	
Input Compression Power	P1dB	dBm	Swept Frequency	+7	+8	+10
2nd Harmonic	2F _o	dBc	Po = 0 dBm Fo = 1.0 GHz	45	50	
Peak Incident Power	P _{inc} (Pk)	dBm	RF Pulse Width = 20 μS, 1% duty		+53	+54
C.W. Incident Power	P _{inc} (CW)	dBm	Swept Frequency		+47	+48
Flat Leakage Power	P _f	dBm	+53 dBm, RF Pulse Width = 20 μS, 1% duty		+17	+18
Spike Leakage Energy	E _S	Ergs	+53 dBm, RF Pulse Width = 20 μS, 1% duty		0.3	0.5
Recovery Time	T _r	μS	(50% Trailing RF , Pulse - 1 dB IL) +53 dBm, RF Pulse Width = 20µS, 1% duty		3	5

LM102202-H-C-301 Absolute Maximum Ratings

Parameter	Absolute Maximum Value	
Operating Temperature	-65 °C to +125 °C	
Storage Temperature	-65 °C to +150 °C	
Junction Temperature	+175 °C	
RF C.W. Incident Power @ +85 °C Source & Load VSWR < 1.2:1	+47 dBm	
RF Peak. Incident Power @ +85 °C Source & Load VSWR < 1.2:1	+53 dBm, RF Pulse Width = 20 μS, 1% duty cycle	
Insertion Loss Rate of Change with Operating Temperature	- 0.0025 dB / ° C	
Assembly Temperature	+260 °C for 10 Seconds	



LM102202-H-C-301 Limiter Schematic





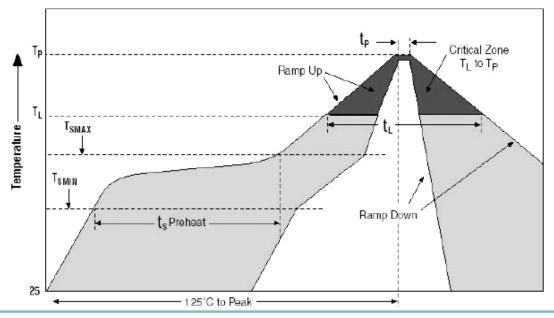
Assembly Instructions

The LM102202-H-C-301 Limiters are capable of being placed onto circuit boards with pick and place manufacturing equipment from tube or tape-reel dispensing. The devices are attached to the circuit board using conventional solder re-flow or wave soldering procedures with RoHS type or Sn 60 / Pb 40 type solders per Table I and Graph I Time-Temperature recommended profile.

Table 1: Time-Temperature Profile for Sn 60 / Pb 40 or RoHS Type Solders

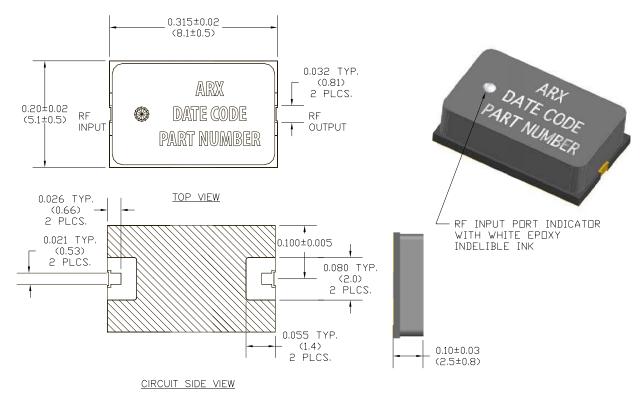
Profile Feature	Sn-Pb Eutectic Assembly	Pb-Free Assembly
Average ramp-up rate (T _L to T _P)	3°C/second maximum	3°C/second maximum
Preheat - Temperature Minimum (T _{SMIN}) - Temperature Maximum (T _{SMAX}) - Time (Minimum to maximum) (t _S)	100°C 150°C 60-120 seconds	150°C 200°C 60-180 seconds
T _{SMAX} to T _L - Ramp-up Rate		3°C/second maximum
Time Maintained above: - Temperature (T _L) - Time (t _{L)}	183°C 60-150 seconds	217°C 60-150 seconds
Peak Temperature (T _P)	225 +0 / -5°C	245 +0/-5°C
Time within 5°C of actual Peak Temperature (T _P)	10-30 seconds	20-40 seconds
Ramp-down Rate	6°C/second maximum	6°C/second maximum
Time 25°C to Peak Temperature	6 minutes maximum	8 minutes maximum

Graph1: Solder Re-Flow Time-Temperature Function





LM102202-Q-B-301 Outline Drawing, Case Style 301, (CS301)



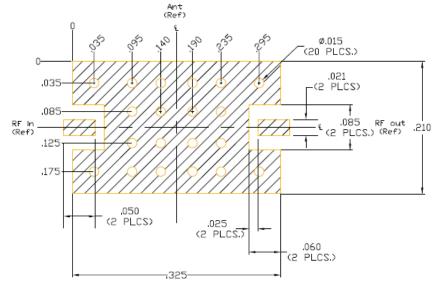
NOTES:

- SUBSTRATE MATERIAL: 20 MIL THICK
- ALUMINA NITRIDE (ALN) RF COVER: BLACK CERAMIC. 2. TOP SIDE AND BACKSIDE METALLIZATION: 100 µ IN. TYPICAL PLATED AU OVER
- 3. DIMENSION IN PARENTHESIS ARE IN MM.

Notes:

1. The Hatched Metal Area on Circuit Side of Device is RF and D.C. Ground.

RF Circuit Solder Footprint for Case Style 301 (CS 301)



RECOMMENDED RF CIRCUIT IS ROGERS, R04350B, 10 MILS THICK.



Part Number Ordering Information:

Part Number	Packaging	
LM102202-H-C-301-T	Tube Packaging	
LM102202-H-C-301-R	Tape-Reel Packaging (Quantities of 250 or 500)	
LM102202-H-C-301-W	Waffle Packaging	
LM102202-H-C-301-E	RF Evaluation Board with Heat Sink	

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